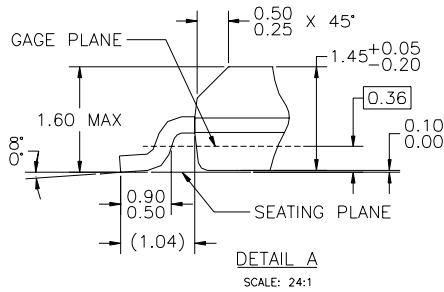
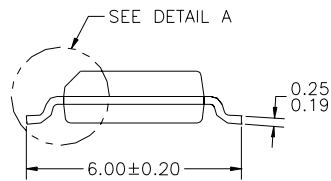
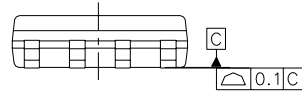
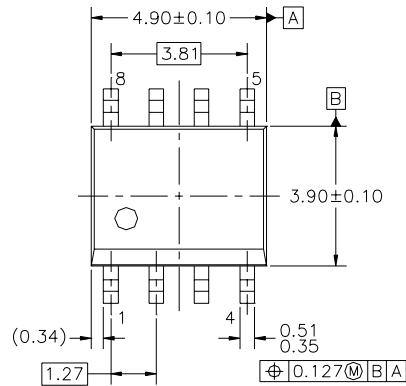


SOIC-8(SO-8) FLMP Package Dimensions

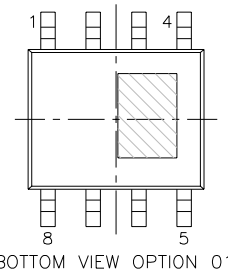


SOIC-8(SO-8) FLMP

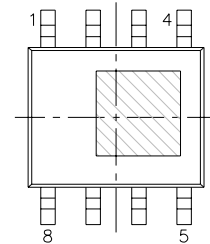


NOTES: UNLESS OTHERWISE SPECIFIED

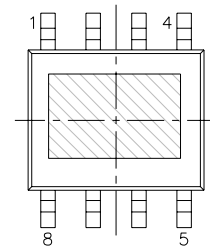
- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) STANDARD LEAD FINISH:
20-80 MICROINCHES NICKEL/
6 MICROINCHES MAX. PALLADIUM
AND GOLD FLASH.
- C) NO JEDEC REGISTERED REFERENCE
AS OF MARCH 2, 2000.
- D) DIE SIZE ASSEMBLY OPTION
OPTION 01: 1.65X2.36 MM
OPTION 02: 2.36X2.36 MM
OPTION 03: 3.68X2.36 MM
OPTION 04: 4.04X2.80 MM



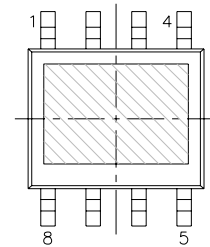
BOTTOM VIEW OPTION 01



BOTTOM VIEW OPTION 02



BOTTOM VIEW OPTION 03



BOTTOM VIEW OPTION 04